

Features

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- Construction utilizes void-free molded plastic technique
- Low reverse leakage
- High forward surge current capability
- High temperature soldering guaranteed
260 /10 seconds at terminals

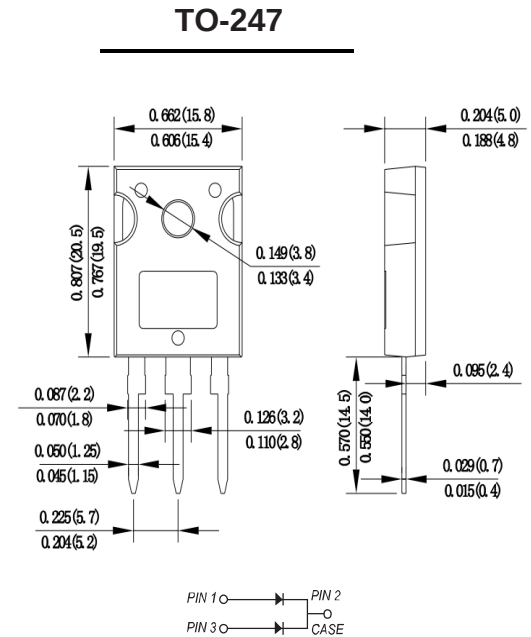
Mechanical Data

Case : Molded plastic body

Terminals : Solder plated, solderable per MIL-STD-750,Method 2026

Polarity : Polarity symbol marking on body

Mounting Position : Any



Dimensions in inches and (millimeters)

Maximum Ratings (Ta=25 unless otherwise specified)

PARAMETER	SYMBOLS	MUR3030PT-BP-CN	UNITS
Maximum repetitive peak reverse voltage	V_{RRM}	300	V
Maximum RMS voltage	V_{RMS}	210	V
Maximum DC blocking voltage	V_{DC}	300	V
Maximum average forward rectified current at $T_L=100^{\circ}\text{C}$	$I_{(AV)}$	30.0	A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	350.0	A
Typical thermal resistance	R_{qJC}	1.5	/ W
Operating junction temperature range	T_J	-55 to +150	
Storage temperature range	T_{STG}	-55 to +150	

Electrical Characteristics (Ta=25 unless otherwise specified)

PARAMETER	SYMBOLS	TYPE	MAX	UNITS
Maximum instantaneous forward voltage per diode at 15A	V_F	1.0	1.3	V
Maximum DC reverse current $T_A = 25$ at rated DC blocking voltage $T_A = 125$	I_R	0.1 50	5 200	μA μA
Maximum reverse recovery time	T_{rr}	35	50	ns

Note:1.Reverse recovery time test condition: $I_F=0.5\text{A}$ $I_R=1.0\text{A}$ $I_{rr}=0.25\text{A}$

Ratings And Characteristic Curves

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

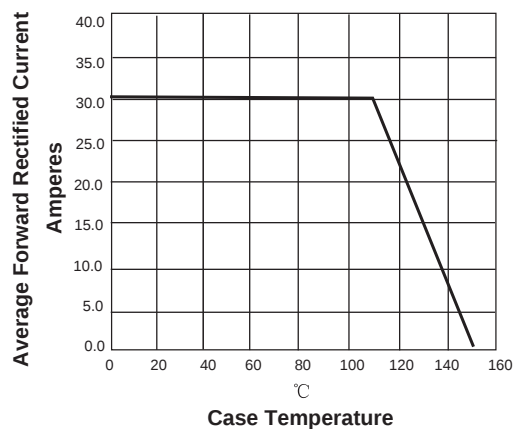


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PERLEG

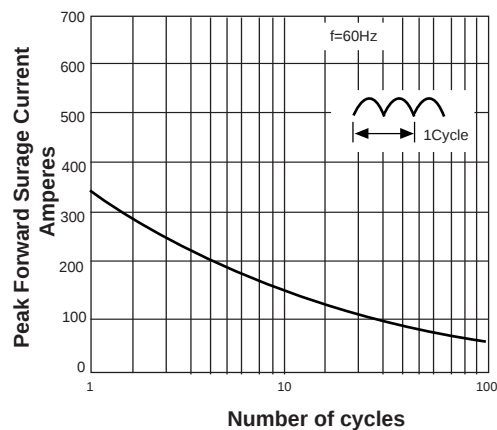


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS

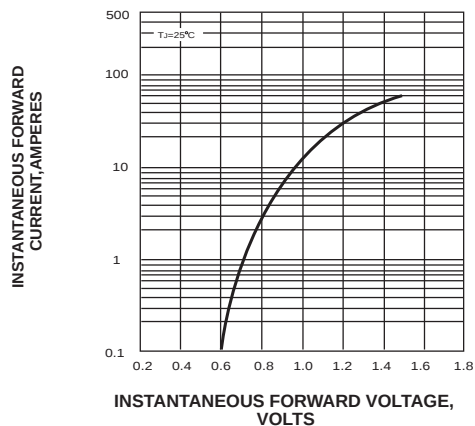
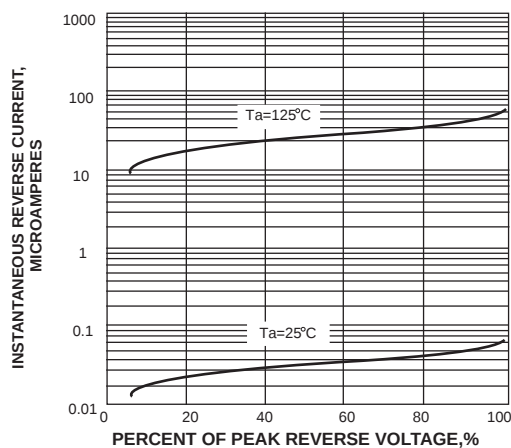
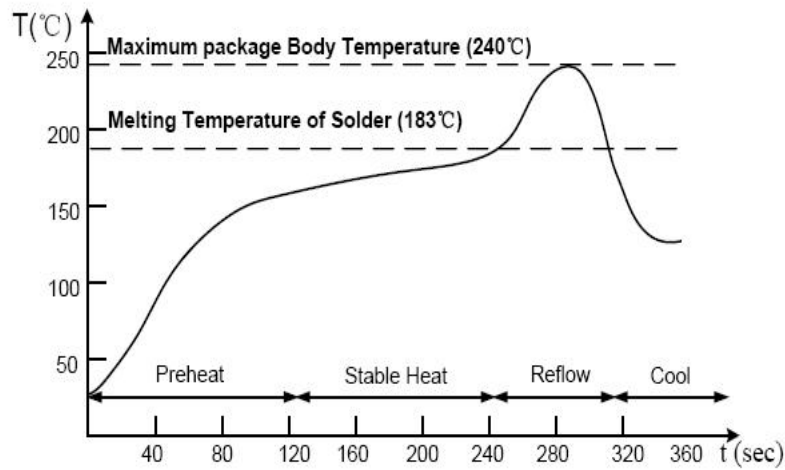


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS



Suggested Soldering Temperature Profile



Note

- Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- The device can be exposed to a maximum temperature of 265°C for 10 seconds.
- Devices can be cleaned using standard industry methods and solvents.
- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

Package Information

Tube Package

Package	Tube (mm)	Q'TY/Tube (Kpcs)	Box Size (mm)	QTY/Box (Kpcs)	Carton Size (mm)	Q'TY/Carton (Kpcs)
TO-247	510*45.5*7.8	0.03	545*150*45	0.45	570*260*150	2.25

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